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**MSM7580**

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**ITU-T G.721 ADPCM TRANSCODER**

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**GENERAL DESCRIPTION**

The MSM7580 is an ADPCM transcoder which is used by the new digital cordless system. It converts 64 kbps voice PCM serial data to 32 kbps ITU-T G.721 ADPCM serial data, and vice versa.

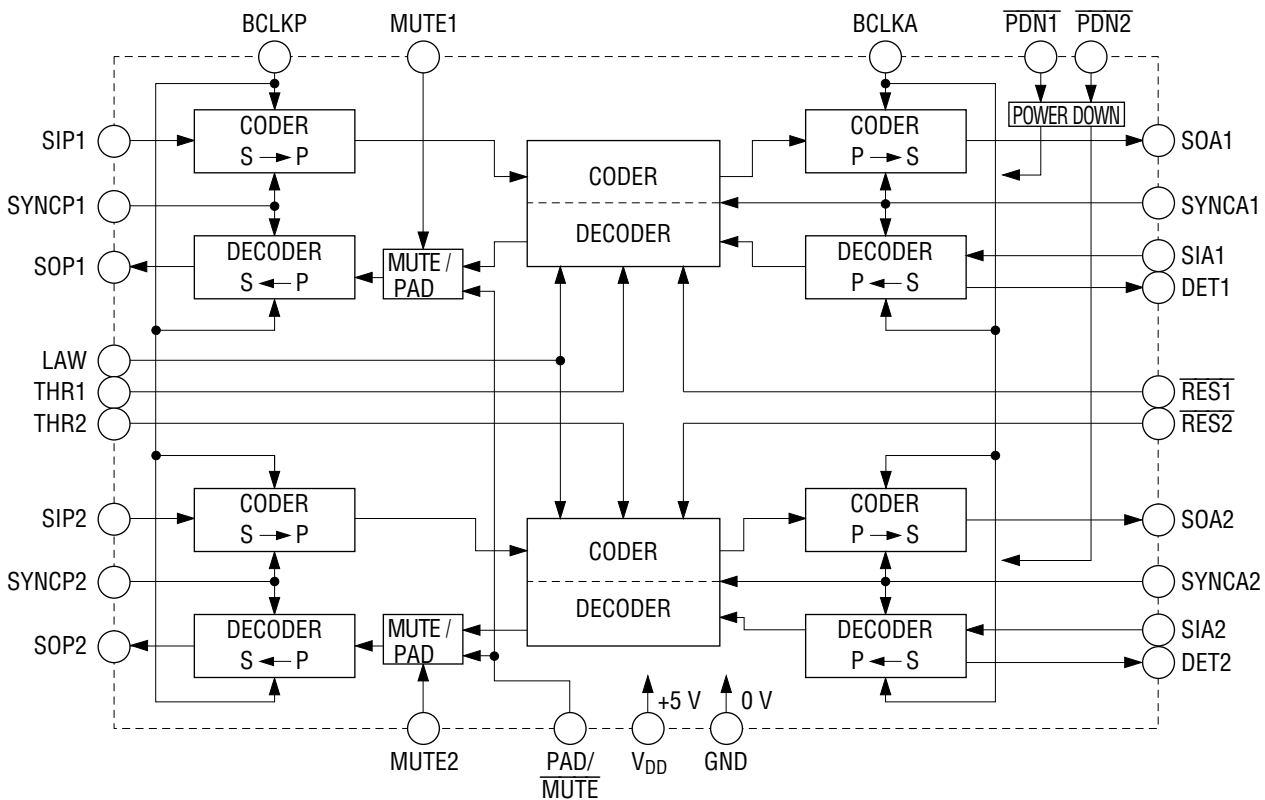
This device consists of two systems with full-duplex voice data channels and a data-through mode.

The MSM7580 provides cost effective solutions for digital cordless office telephone systems which are incorporated into PABXs and for the public base stations which are connected to the central office through digital PSTNs.

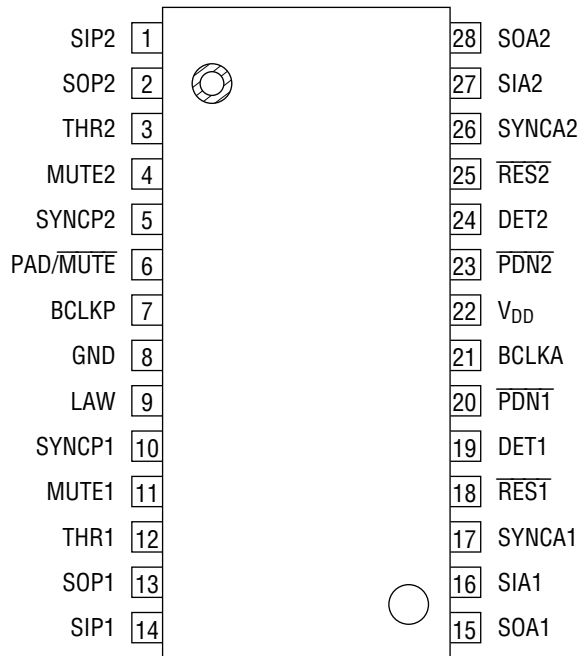
**FEATURES**

- Conforms to ITU-T G.721
- Built-in Full-duplex Transcoder with Two Data channels
- PCM companding Law: A-law/ $\mu$ -law selectable
- Synchronized Operation between coder and decoder, and between two channels.
- Serial PCM Data Transmission Speed: 64 kbps to 2048 kbps
- Serial ADPCM Data Transmission Speed: 32 kbps to 2048 kbps
- Hardware Reset – ITU-T G.721 Optional Reset – for each channel
- Power Down Control for each channel
- Decoder (ADPCM → PCM ) MUTE Mode and PAD Mode for each channel
- ADPCM Data-through Mode
- Capable of time slot conversion
- Special ADPCM Input Data Code ("0000") Detector for each channel
- Master Clock Signal : Not necessary
- Power supply voltage/Consumption current :  
+5 V  $\pm$ 10%, 2.5 mA/channel
- Package :  
28-pin plastic SOP (SOP28-P-430-1.27-K) (MSM7580GS-K)

**BLOCK DIAGRAM**



**PIN CONFIGURATION (TOP VIEW)**



**28-Pin Plastic SOP**

## PIN AND FUNCTIONAL DESCRIPTIONS

### GND

Ground, 0 V.

### SIP1, SOP1

PCM serial data input (SIP1) and output (SOP1) for Channel 1.

SOP1 is an open-drain output, which goes into a high impedance state after a continuous 8-bit serial data output.

### SIP2, SOP2

PCM serial data input (SIP2) and output (SOP2) for Channel 2.

SOP2 is an open-drain output, which goes into a high impedance state after a continuous 8-bit serial data output.

### PAD/ $\overline{\text{MUTE}}$

Control input for the selection of PAD or MUTE mode.

When digital "1" is input, the PAD mode is selected and when digital "0" is input, the MUTE mode is selected.

### THR1, THR2

Control pins for the data through modes.

THR1 and THR2 are for Channel 1 and Channel 2, respectively. The data-through mode is selected when digital "1" is applied to THR1 and THR2. In this mode, 8-bit serial input data applied to SIA1 and SIA2 (ADPCM data input) is passed to the PCM serial data output pins, SOP1 and SOP2, without any data modification. SOP1 and SOP2 go to the high impedance state after the output of 8-bit data has been applied to SIA1 and SIA2.

Conversely 8-bit serial input data applied to SIP1 and SIP2 (PCM data input) is passed to ADPCM serial data output pins, SOA1 and SOA2, without any data modification.

SOA1 and SOA2 go to the high impedance state after the output of 8-bit data has been applied to SIP1 and SIP2.

Since ADPCM and PCM data interfaces have the mutually independent signal input pins for synchronizing signals the time slots for data input and output can be exchanged between them. Some timing at which data may be deleted or duplicated as described in "Notes on Usage" should not be used.

### MUTE1, MUTE2

Setting a digital "1" at these pins sets the PCM output to the idle pattern state regardless of the ADPCM input data, when the MUTE mode is selected by the PAD/ $\overline{\text{MUTE}}$  pin.

When the PAD mode is selected, the PCM output has a 12 dB loss.

Normally, these pins are set to a digital "0".

When the data through mode is selected, the function of these pins is invalid.

## **SYNCP1, SYNCP2**

Synchronous signal input.

SYNCP1 and SYNCP2 control the PCM data input/output timing for Channel 1 (SIP1, SOP1) and Channel 2 (SIP2, SOP2), respectively.

Since other synchronous signal input pins SYNCA1 and SYNCA 2 for ADPCM interfaces are also provided, the PCM and ADPCM data can be input or output with different timing.

PCM and ADPCM data interfaces can be used at a mutually independent timing except same timing.

Note: When PCM and ADPCM data interfaces are used at a mutually independent timing, the timing described in "Notes on Usage" should not be used.

## **BCLKP**

Bit clock input.

This signal defines the PCM data transmission speed at the PCM data input/output pins.

BCLKP is used for Channels 1 and 2. Since BCLKA defines the data rate of the ADPCM data interface, the PCM and ADPCM data can be input or output at different speeds.

## **LAW**

PCM data companding law (A-law/ $\mu$ -law) selection.

Digital "1" and "0" correspond to A-law and  $\mu$ -law, respectively.

## **$\overline{\text{PDN1}}$ , $\overline{\text{PDN2}}$**

Power down mode selection.

$\overline{\text{PDN1}}$  and  $\overline{\text{PDN2}}$  can be independently set to power down mode. When a digital "0" is applied, these pins are in the power-down mode.

## **SIA1, SOA1**

ADPCM serial data input (SIA1) and output (SOA1) pins for Channel 1.

SOA1 is an open-drain pin and enters to the high impedance state after outputting a continuous 4-bit serial data stream. When the data-through mode is selected, SOA1 enters to the high impedance state after outputting an 8-bit serial data stream.

## **SIA2, SOA2**

ADPCM serial data input (SIA2) and output (SOA2) pins for Channel 2.

These pins function the same as SIA1 and SOA1.

## SYNCA1 , SYNCA2

Synchronous signal input pins.

SYNCA1 and SYNCA 2 control the ADPCM data input/output timing for Channel 1 (SIA1, SOA1) and Channel 2 (SIA2, SOA2), respectively.

The ADPCM data can be input or output with timing other than the PCM data interface.

Therefore PCM and ADPCM interfaces can be used at a mutually independent timing except some timing.

Since master clocks are generated by the internal PLL using SYNCA, a synchronous signal should be input to these pins.

Note: When PCM and ADPCM data interfaces are used at a mutually independent timing, the timing described in "Notes on Usage" should not be used.

## DET1, DET2

Special ADPCM input data pattern detect pins.

When a 4-bit continuous "0" pattern at the ADPCM input pins Channel 1 (STA1) and Channel 2 (SIA2) is detected, DET1 and DET2 go from a digital "0" to a digital "1" state.

A digital "1" is output at the rising edge of the clock.

The fourth data bit (LSB) is clocked into the register by the bit clock (BCLKA) and the held there until the rising edge in the next time frame.

When detecting the special data pattern in the next time frame, the digital "1" on the pins DET (1, 2) is remains. When the THR1 pin or THR2 pin is at digital "1" level, the functions of these pins are invalid.

## RES1, RES2

Algorithm reset signal input pins for Channel 1 ( $\overline{\text{RES1}}$ ) and Channel 2 ( $\overline{\text{RES2}}$ ).

When a digital "0" is applied, the entire transcoder goes to its initial state.

This reset is defined by ITU-T G.721 and is an optional reset.

## BCLKA

Bit clock input pin used to define the data transmission speed at the ADPCM interface.

This pin can be used for Channels 1 and 2, which allows the ADPCM data interface speed to be defined differently than the PCM data interface speed.

## V<sub>DD</sub>

Power supply.

The device must operate at +5 V  $\pm$ 10%.

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Rating	Unit
Power Supply Voltage	$V_{DD}$	—	0 to 7	V
Digital Input Voltage	$V_{DIN}$	—	-0.3 to $V_{DD} + 0.3$	V
Storage Temperature	$T_{STG}$	—	-55 to +150	°C

**RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage	$V_{DD}$	—	4.5	—	5.5	V
Operating Temperature	$T_a$	—	-30	+25	+80	°C
Digital Input High Voltage	$V_{IH}$	All Digital Input Pins	2.2	—	$V_{DD}$	V
Digital Input Low Voltage	$V_{IL}$		0	—	0.6	V
Bit Clock Frequency	$F_{BCLKA}$	BCLKA	32	—	2048	kHz
	$F_{BCLKP}$	BCLKP	64	—	2048	kHz
Synchronous Signal Frequency	$F_{SYNC}$	SYNCP1, SYNCP2, SYNCA1, SYNCA2	—	8.0	—	kHz
Clock Duty Ratio	$D_C$	BCLKA, BCLKP	30	50	70	%
Digital Input Rise Time	$t_{ir}$	All Digital Input Pins	—	—	50	ns
Digital Input Fall Time	$t_{if}$		—	—	50	ns
Synchronous Signal Timing CODER	$t_{XS}$	BCLKA, BCLKP to SYNCP	100	—	—	ns
	$t_{SX}$	SYNCP to BCLKA, BCLKP	100	—	—	ns
Synchronous Signal Timing DECODER	$t_{SX}$	BCLKA, BCLKP to SYNCA	100	—	—	ns
	$t_{SR}$	SYNCA to BCLKA, BCLKP	100	—	—	ns
Synchronous Signal Width	$t_{WS}$	SYNCP1, SYNCP2, SYNCA1, SYNCA2	1 BCLK	—	100	μs
Data Set-up Time	$t_{DS}$	—	100	—	—	ns
Data Hold Time	$t_{DH}$	—	100	—	—	ns
Digital Output Load	$R_{DL}$	SOP1, SOP2, SOA1, SOA2 (Pull-up Resistor)	500	—	—	Ω
	$C_{DL}$	SOP1, SOP2, SOA1, SOA2, DET1, DET2	—	—	100	pF

## ELECTRICAL CHARACTERISTICS

### DC Characteristics

( $V_{DD} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_a = -30^\circ\text{C to }+80^\circ\text{C}$ )

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Power Supply Current	$I_{DD1}$	Power On Mode: 2 Channels	—	5	10	mA
	$I_{DD2}$	Power Down Mode: 2 Channels	—	0.1	0.2	mA
Input High Voltage	$V_{IH}$	—	2.2	—	$V_{DD}$	V
Input Low Voltage	$V_{IL}$	—	0.0	—	0.6	V
Input Leakage Current	$I_{IH}$	$V_I = V_{DD}$	—	—	2.0	$\mu\text{A}$
	$I_{IL}$	$V_I = 0\text{ V}$	—	—	0.5	$\mu\text{A}$
Digital Output High Voltage	$V_{OH}$	DET1, DET2 : $I_{OH} = -0.4\text{ mA}$	2.8	—	$V_{DD}$	V
Digital Output Low Voltage	$V_{OL1}$	1 LSTTL, Pull-up : $500\ \Omega$	0.0	0.2	0.4	V
	$V_{OL2}$	DET1, DET2 : $I_{OL} = 1.6\text{ mA}$	0.0	0.2	0.4	V
Output Leakage Current	$I_{OL}$	SOP1, SOP2, SOA1, SOA2	—	—	10	$\mu\text{A}$
Input Capacitance	$C_{IN}$	—	—	5	—	pF

### AC Characteristics

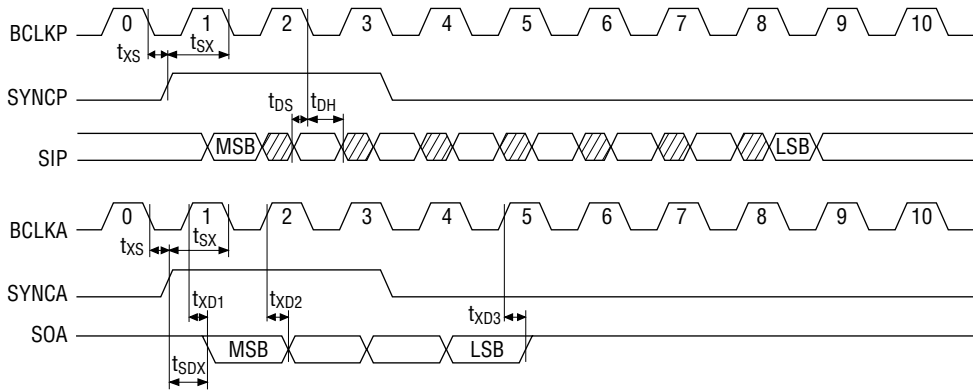
( $V_{DD} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_a = -30^\circ\text{C to }+80^\circ\text{C}$ )

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Digital Output Delay Time	$t_{SDX}$	1 LSTTL + $100\ \text{pF}$ Pull-up: $500\ \Omega$	0	—	200	ns
	$t_{SDR}$		0	—	200	ns
	$t_{XD1}, t_{RD1}$		0	—	200	ns
	$t_{XD2}, t_{RD2}$		0	—	200	ns
	$t_{XD3}, t_{RD3}$		0	—	200	ns
	$t_{DD1}$		0	—	200	ns
	$t_{DD2}$		0	—	200	ns

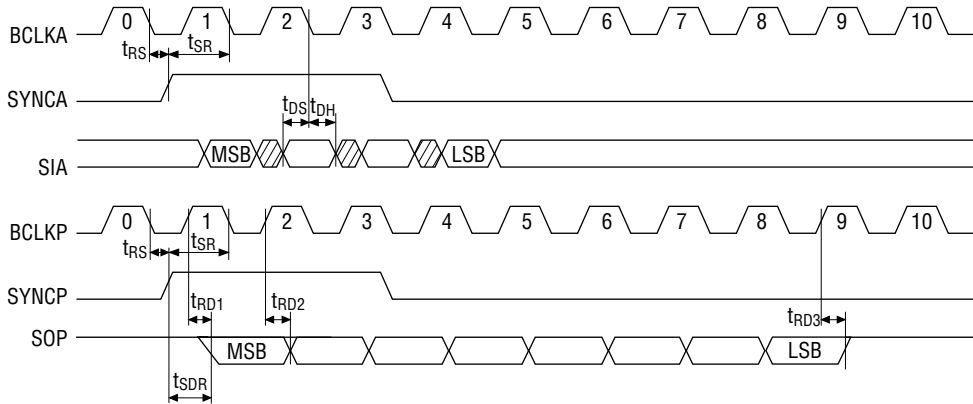


**TIMING DIAGRAM**

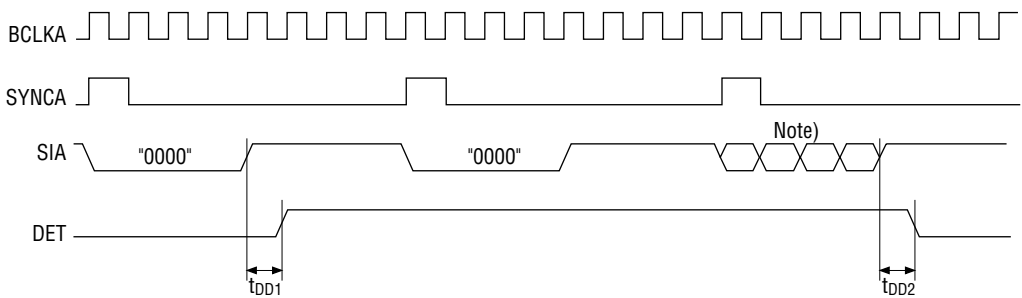
**CODER**



**DECODER**

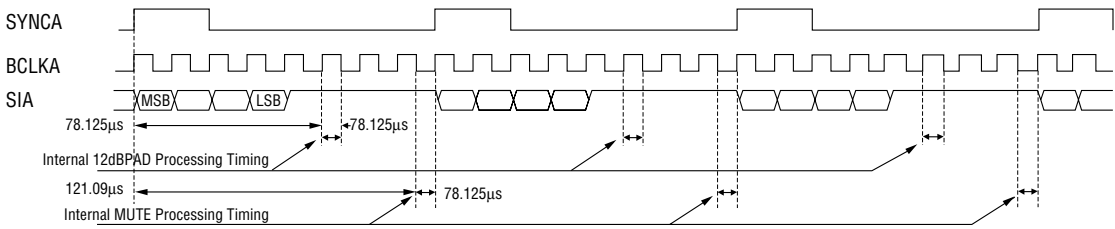


**DET ("0000" detection) Output Timing**

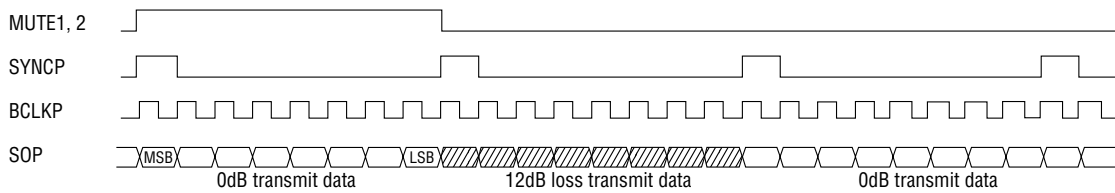


**Note:** 4-bit data pattern except "0000"

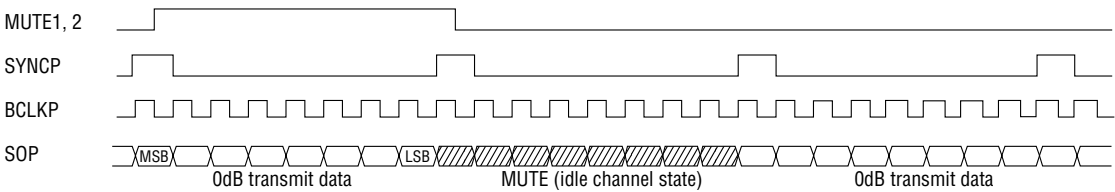
**PAD/MUTE Processing Timing**



**PAD Mode; MUTE1 and MUTE 2 Timings PAD/MUTE="H"**



**MUTE Mode; MUTE1 and MUTE 2 Timings PAD/MUTE="L"**



As mentioned above, PAD and MUTE processings are carried out according to the rising edge of SYNCA.

Even if BCLK is not 128 kHz, these processings are performed in the absolute time counted from the rising edge of SYNCA.

Therefore, MUTE1 and MUTE 2 pins must be controlled so as to cover there processings.

### THR Processing Timing

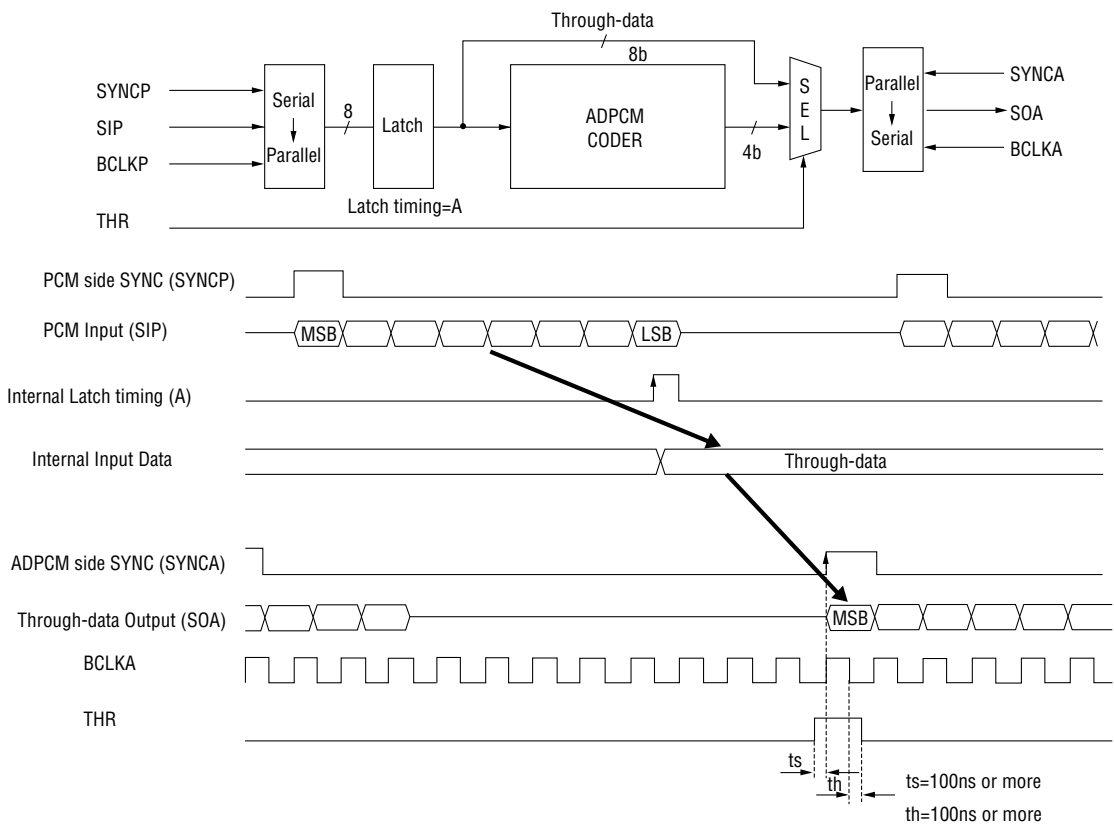
Timing Block Diagrams, when CODER and DECODER output data, are shown in the following figures.

The parallel to serial conversion of the output unit employs a load format and the load point is at the rising edge of a synchronous signal.

Therefore, input THR signal with respect to SYNCA for CODER with timing of satisfying  $t_s$  and  $t_h$  conditions shown in the figure.

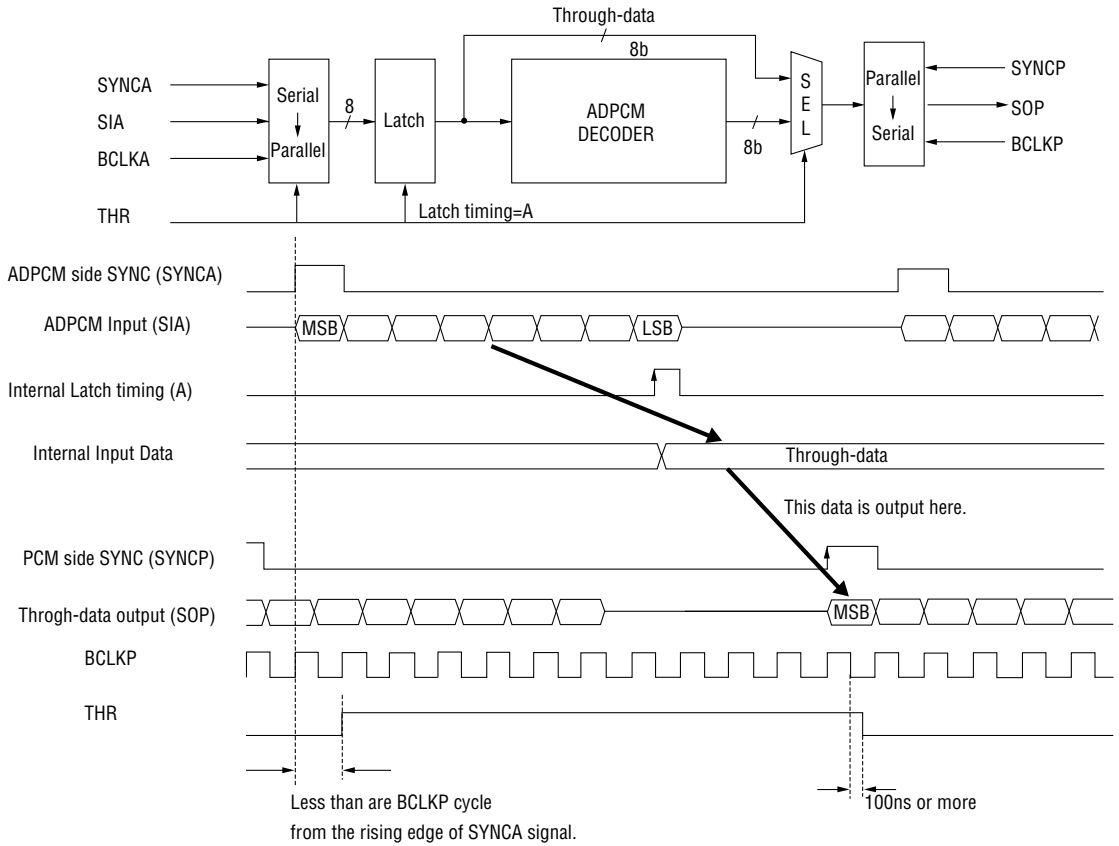
For DECODER, THR signal should be input even when through-data is input. The input timing should satisfy the conditions shown in the following figures.

### CODER

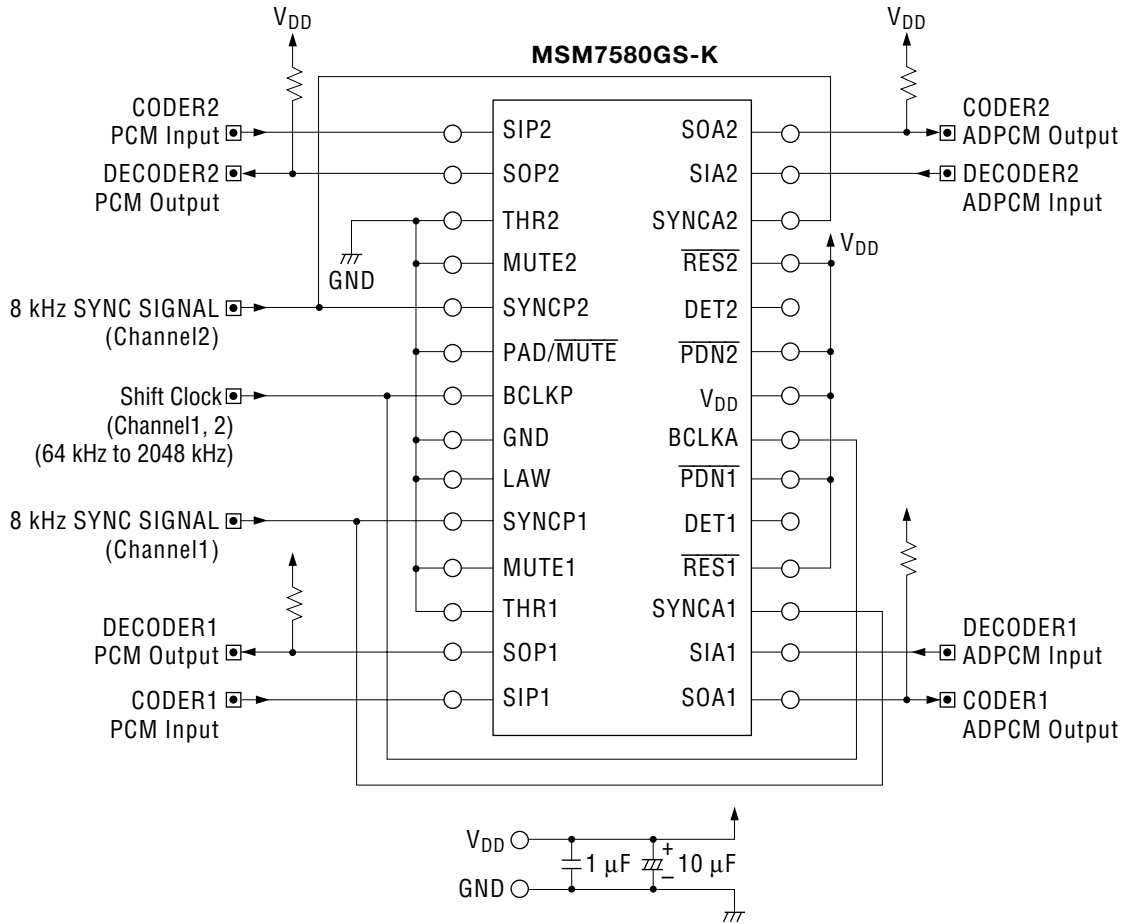


Note: That data-ship may occur when the rising edge (data load point) of SYNCA and input of the internal latch overlap each other.

DECODER

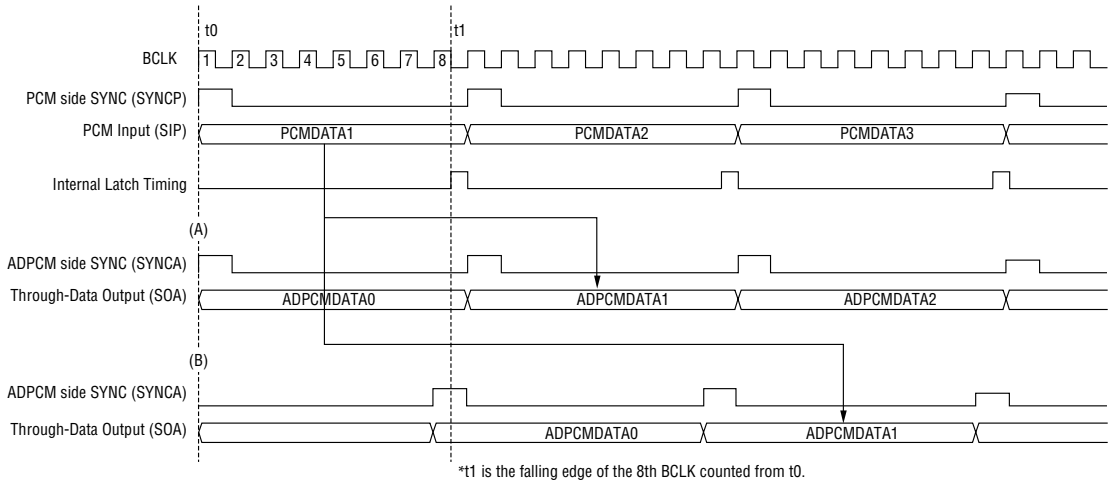


APPLICATION CIRCUIT



## NOTES ON USAGE

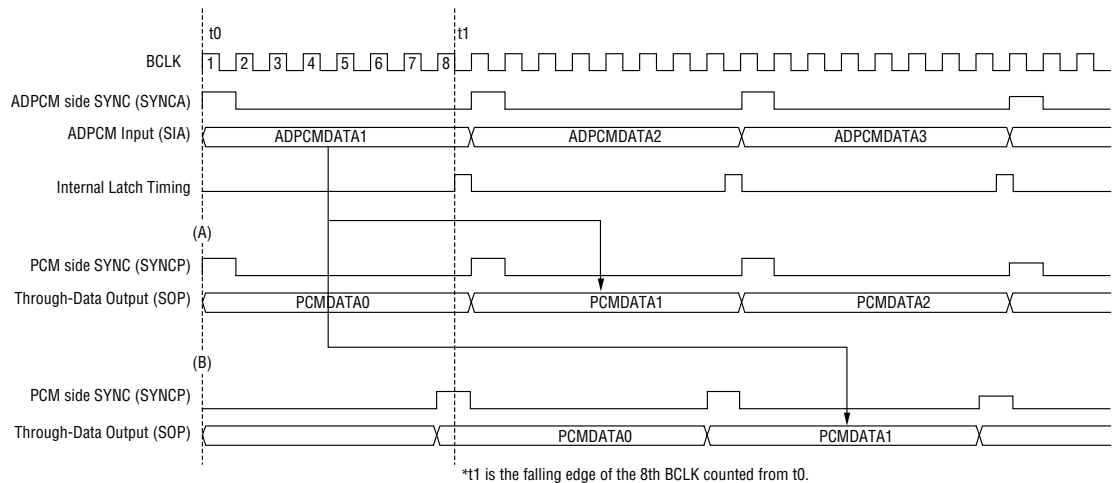
### (1) Through Mode (CODER Side)



- (A) When SYNCA rises after  $t_1$ , PCMDATA1 is output to ADPCMDATA1.
- (B) When SYNCA rises before  $t_1$ , PCMDATA1 is output to ADPCMDATA0.

If SYNCA rises near the  $t_1$  and jitter occurs, data slip may occur. Therefore SYNCA should not rise in the range of  $\pm 500$ ns from  $t_1$ . Data slip means that data is deleted or the same data is output twice.

### (2) Through Mode (DECODER Side)

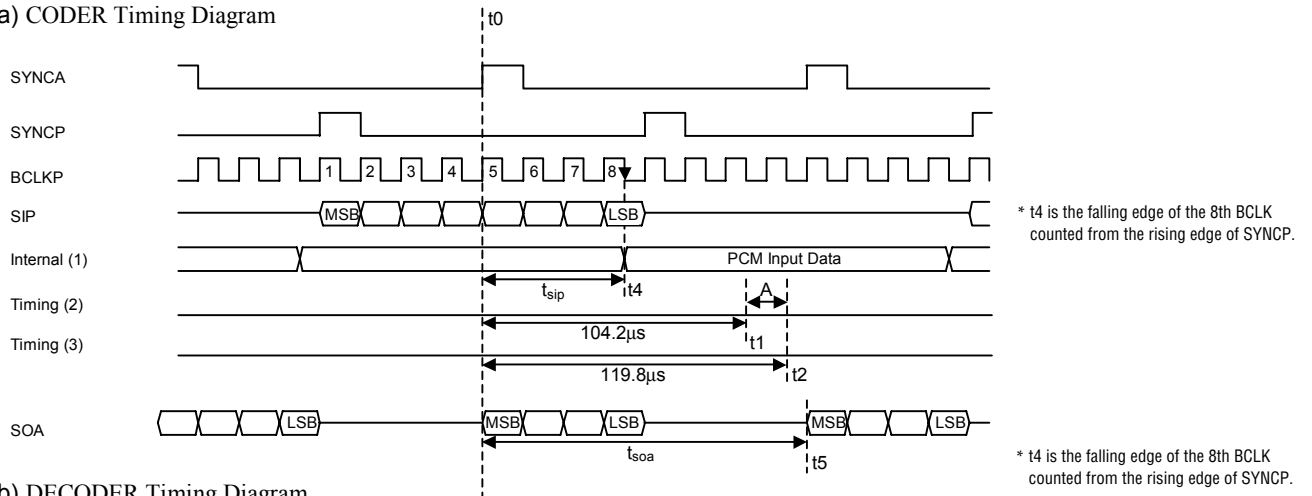


- (A) When SYNCA rises after  $t_1$ , ADPCMDATA1 is output to PCMDATA1.
- (B) When SYNCA rises before  $t_1$ , ADPCMDATA1 is output to PCMDATA0.

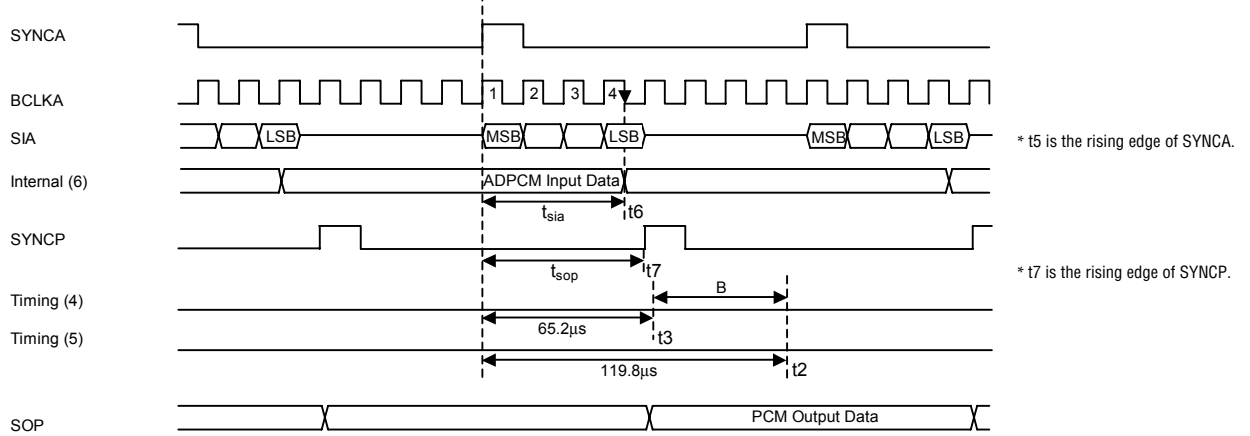
If SYNCP rises near the  $t_1$  and jitter occurs, data slip may occur. Therefore SYNCA should not rise in the range of  $\pm 500$ ns from  $t_1$ . Data slip means that data is deleted or the same data is output twice.

(3) PCM→ADPCM, ADPCM→PCM during Transcode

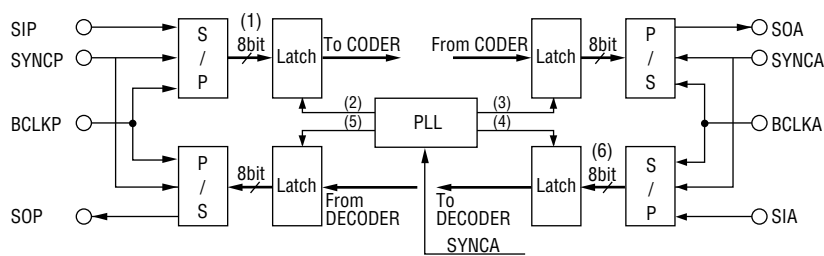
(a) CODER Timing Diagram



(b) DECODER Timing Diagram



(c) Internal Circuit Configuration



In this device, internal operating signals are generated according to the ADPCM side SYNC (SYNCA) signal.

The timings are shown in the figures (a) and (b);

The arithmetic operation of CODER is performed at "A" in the figure (a).

The arithmetic operation of DECODER is performed at "B" in the figure (b).

Therefore, when the conversion delay time  $T_{sip}$  of the CODER is less than  $t_1$ , ADPCM is output at the timing of  $T_{soa}$ .

When  $T_{sip}$  is more than  $t_1$ , ADPCM is output at the timing of  $T_{soa} + 125\mu s$ .

For DECODER, when  $T_{sia} < t_3$  and  $T_{sop} < t_2$ , the conversion delay time is  $T_{sop} - T_{sia}$ .

As mentioned above, a data slip may occur at  $T_{sip} = t_1$  in CODER, and at  $T_{sia} = t_3$  and  $T_{sop} = t_2$  in DECODER.

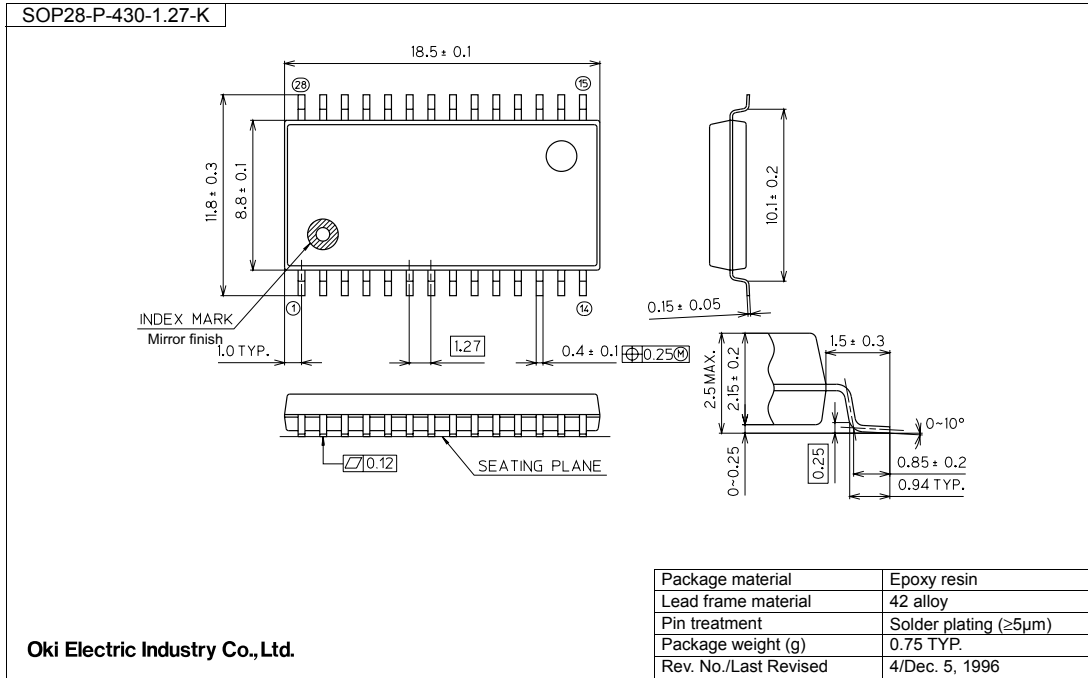
Therefore, the timings of SYNC signals of both PCM and ADPCM sides should not be set up in the range about  $\pm 500\text{nsec}$  of  $T_{sip} = t_1$ ,  $T_{sia} = t_3$  and  $T_{sop} = t_2$ .

For normal operation, SYNC clocks for ADPCM and PCM sides should be continuous at 8 kHz and synchronized with each other even if their phases are different.



PACKAGE DIMENSIONS

(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

**REVISION HISTORY**

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
E2U0031-39-61	Jun. 1999	—	—	Final edition 3
FEDL7580-04	Aug. 12, 2004	—	—	Final edition 4
		15	15	Modified Sections (a), CODER Timing Diagram, and (b), DECODER Timing Diagram.

NOTICE

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